ICCCAS 2025

CALL FOR PAPERS

2025 IEEE The 14th International Conference on Communications, Circuits and Systems

Wuhan, China | May 23-25, 2025

Important Dates

Submission Deadline	**February 15, 2025**
Notification Deadline	March 10, 2025
Registration Deadline	March 25, 2025

ICCCAS Special Sessions

Session 1: Analog/Mixed-Signal/RF/Power Circuits and Related Technologies in the Digital Society

Chair: Haruo Kobayashi (SMIEEE), Gunma University, Japan

Session 2: Quantum Science and Technology

Chair: Randy Kuang, Quantropi Inc., Ottawa, Canada & Michel Barbeau, Carleton University, Canada

Session 3: Quantum Secure Communication

Chair: Xueqin Jiang, Donghua University, China

Session 4: Analog Integrated Circuit

Chair: Haijun Lin, Xiamen University of Technology, China

Session 5: Information and Communication Technology in Optics and Photonics

Chair: Weng Wen, University of Electronic Science and Technology of China, China

Session 6: Radar/Sonar Environmental Observation, Communication and Remote Sensing

Chair: Jiahua Zhu (SMIEEE), National University of Defense Technology, China

Session 7: Biomedical Instrumentation and Signal Processing for Disease Diagnosis, Prognosis, and Treatment

Chair: Md Kafiul Islam (SMIEEE), Independent University, Bangladesh

Session 8: 6G Wireless Communication Networks

Chair: Jie Huang, Southeast University, China

Session 9: Environment Sensing Aided UAV Positioning and Communication

Chair: Chen He, Northwest University, China

Publication

IEEE The accepted and presented papers will be published in the **ICCCAS Conference Proceedings**. Conference content will be submitted for inclusion into **IEEE Xplore** and indexed by **Ei Compendex and Scopus**, etc.

ICCCAS 2025 has been included in IEEE event list! (Read More)

SCIE/Ei/Scopus Journal Publication

Selected registered papers with proper extension will be recommended to below journals for potential publication

Journal of Communications and Information Networks (ISSN: 2096-1081)

CiteScore(2022): **4.0**
Indexing: **Chinese Science Citation Database (CSCD), Ei Compendex, Scopus**

IET Communications (ISSN: 1751-8636)

Impact Factor: **1.6**
CiteScore(2022): **4.0**
Indexing: **SCIE, EI, Scopus,** Inspec, ACM, DOAJ

Sensors (ISSN 1424-8220)

Impact Factor: **3.847**
Indexing: **SCIE (Web of Science), Scopus, Ei Compendex**, PubMed, Inspec, etc.

Journal of Marine Science and Application (ISSN: 1671-9433)

Indexing: **Scopus,** Google Scholar, SCImago, CSA, CSCD, CJCR

IET Quantum Communication (ISSN: 2632-8925)

CiteScore(2022): **3.8**
Indexing: **EI, Scopus,** Inspec, DOAJ

Journal of Communications (ISSN: 1796-2021)

CiteScore: 2.3
Abbreviated Title: J. Commun.
Indexing: **Scopus**, DBLP; CrossRef, EBSCO, Google Scholar; CNKI, etc.

Conference Topics

Communications
Communication and Information System Security
Communication Software and Multimedia
Molecular, Biological and Multi-Scale Communications
Green Communication Systems and Networks
Circuits and Systems
Beyond CMOS: Nanoelectronics and Hybrid Systems Integration
Neural Networks and Neuromorphic Engineering
Analog and Mixed Signal Circuits and Systems
More details, please access: **http://www.icccas.org/cfp.html**

Keynote Speakers

Prof. Xiaofeng Liao, Chongqing University, China
Fellow of the IEEE, AIAA

Prof. Yonghui Li, University of Sydney, Australia
Fellow of the IEEE

Conference Awards

◆ Outstanding Young Scholar Award – **Deadline: April 10, 2025**
Eligibility: Authors within the age of 40 by May 13 with a doctor degree.
◆ Best Reviewer Award
◆ Best Student Paper Award (Eligibility: University Students Only)
◆ Best Paper Award (Eligibility: All Conference Accepted Papers)
◆ Excellent Oral Presentation Award
◆ Excellent Poster Presentation Award
For details, please visit: **http://www.icccas.org/award.html**

Publication History

Accepted and presented papers of **13-year ICCCAS** have been successfully published and indexed by **EI Compendex & Scopus**.

ICCCAS 2024: Xiamen, China - ISBN: 979-8-3503-8627-1 (**The papers were published 3 months after conference and were indexed 1 month after online**.)
ICCCAS 2023: Singapore - ISBN: 978-981-97-2635-6
ICCCAS 2022: Online - ISBN: 978-1-6654-6989-0
ICCCAS 2018: Chengdu, China - ISBN: 978-1-5386-9387-2
ICCCAS 2013: Chengdu, China - ISBN: 978-1-4799-3051-7
ICCCAS 2010: Chengdu, China - ISBN: 978-1-4244-8224
ICCCAS 2009: Milpitas, CA, USA - ISBN: 978-1-4244-4886-9
ICCCAS 2008: Xiamen, China - ISBN: 978-1-4244-2063-6
ICCCAS 2007: Kokura, Japan - ISBN: 978-1-4244-1473-4
ICCCAS 2006: Guilin, China - ISBN: 0-7803-9584-0
ICCCAS 2005: Hong Kong, China - ISBN: 0-7803-9015-6
ICCCAS 2004: Chengdu, China - ISBN: 0-7803-8647-7
ICCCAS 2002: Chengdu, China - ISBN: 0-7803-7547-5
More info, please visit: **http://www.icccas.org/history.html**

Submission Guidelines

Submission Type:
Full Paper (**English, no less than 4 pages normally**, 10 pages maximum. 5-6 pages are recommended)
Abstract (English, within 300 words)
Submission Method:

EC Online Submission System:
https://easychair.org/conferences/?conf=icccas2025

Email Submission: icccas@vip.163.com
More details, please access: **http://www.icccas.org/sub.html**

Contact US

Conference Secretariat: Ms. Tammy Lee

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(Office time 9:30 - 18:00, Time zone: GMT+8; Monday to Friday)

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